

### SOT-23



#### Pin Definition:

1. Gate
2. Source
3. Drain

### PRODUCT SUMMARY

$V_{DS}$ (V)	$R_{DS(on)}$ (m $\Omega$ )	$I_D$ (A)
20	33 @ $V_{GS} = 4.5V$	4.9
	40 @ $V_{GS} = 2.5V$	4.4
	100 @ $V_{GS} = 1.8V$	2.9

### Features

- Advance Trench Process Technology
- High Density Cell Design for Ultra Low On-resistance

### Application

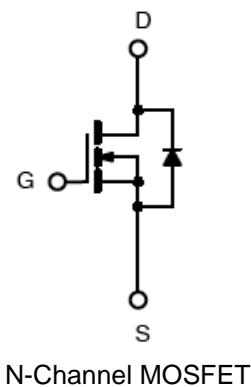
- Load Switch
- PA Switch

### Ordering Information

Part No.	Package	Packing
TSM2314CX RF	SOT-23	3Kpcs / 7" Reel
TSM2314CX RFG	SOT-23	3Kpcs / 7" Reel

**Note:** "G" denotes Halogen Free Product.

### Block Diagram



### Absolute Maximum Rating ( $T_a = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current, $V_{GS} @ 4.5V$ .	$I_D$	4.9	A
Pulsed Drain Current, $V_{GS} @ 4.5V$	$I_{DM}$	15	A
Continuous Source Current (Diode Conduction) <sup>a,b</sup>	$I_S$	1.0	A
Maximum Power Dissipation	$P_D$	$T_a = 25^\circ C$	1.25
		$T_a = 75^\circ C$	0.8
Operating Junction Temperature	$T_J$	+150	$^\circ C$
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^\circ C$

### Thermal Performance

Parameter	Symbol	Limit	Unit
Junction to Case Thermal Resistance	$R_{\theta_{JF}}$	75	$^\circ C/W$
Junction to Ambient Thermal Resistance (PCB mounted)	$R_{\theta_{JA}}$	120	$^\circ C/W$

Notes:

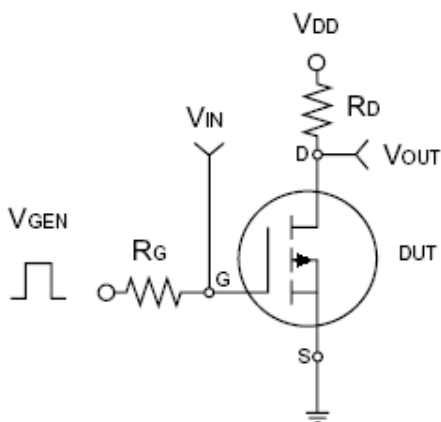
- a. Pulse width limited by the Maximum junction temperature
- b. Surface Mounted on FR4 Board,  $t \leq 5$  sec.

### Electrical Specifications (Ta = 25°C unless otherwise noted)

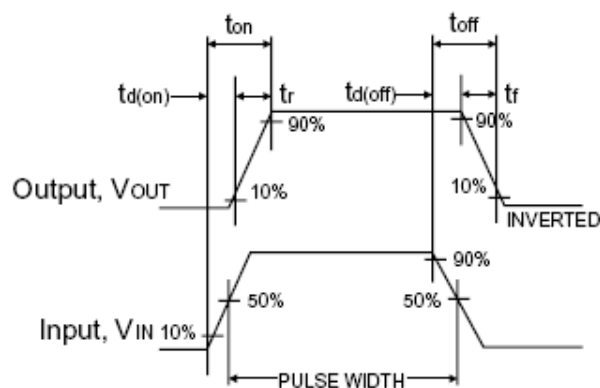
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	$BV_{DSS}$	20	--	--	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	0.6	0.85	1.2	V
Gate Body Leakage	$V_{GS} = \pm 4.5V, V_{DS} = 0V$	$I_{GSS}$	--	--	$\pm 1.5$	$\mu A$
Zero Gate Voltage Drain Current	$V_{DS} = 16V, V_{GS} = 0V$	$I_{DSS}$	--	--	1.0	$\mu A$
On-State Drain Current	$V_{DS} \geq 10V, V_{GS} = 4.5V$	$I_{D(ON)}$	15	--	--	A
Drain-Source On-State Resistance	$V_{GS} = 4.5V, I_D = 4.9A$	$R_{DS(ON)}$	--	27	33	m $\Omega$
	$V_{GS} = 2.5V, I_D = 4.4A$		--	33	40	
	$V_{GS} = 1.8V, I_D = 2.9A$		--	80	100	
Forward Transconductance	$V_{DS} = 15V, I_D = 5.0A$	$g_{fs}$	--	40	--	S
Diode Forward Voltage	$I_S = 1.0A, V_{GS} = 0V$	$V_{SD}$	--	0.8	1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$V_{DS} = 10V, I_D = 5.0A, V_{GS} = 4.5V$	$Q_g$	--	11	14	nC
Gate-Source Charge		$Q_{gs}$	--	1.5	--	
Gate-Drain Charge		$Q_{gd}$	--	2.1	--	
Input Capacitance	$V_{DS} = 10V, V_{GS} = 0V, f = 1.0MHz$	$C_{iss}$	--	900	--	pF
Output Capacitance		$C_{oss}$	--	140	--	
Reverse Transfer Capacitance		$C_{rss}$	--	100	--	
<b>Switching<sup>c</sup></b>						
Turn-On Delay Time	$V_{DD} = 10V, R_L = 10\Omega, I_D = 1A, V_{GEN} = 4.5V, R_G = 6\Omega$	$t_{d(on)}$	--	0.53	0.8	ns
Turn-On Rise Time		$t_r$	--	1.4	2.2	
Turn-Off Delay Time		$t_{d(off)}$	--	13.5	20	
Turn-Off Fall Time		$t_f$	--	5.9	9	

**Notes:**

- a. pulse test:  $PW \leq 300\mu S$ , duty cycle  $\leq 2\%$
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.



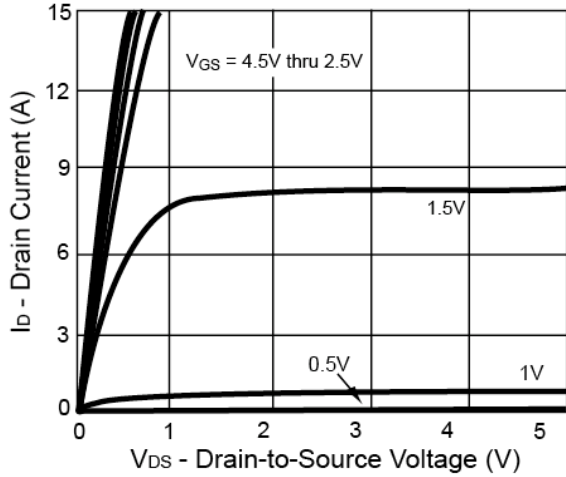
**Switching Test Circuit**



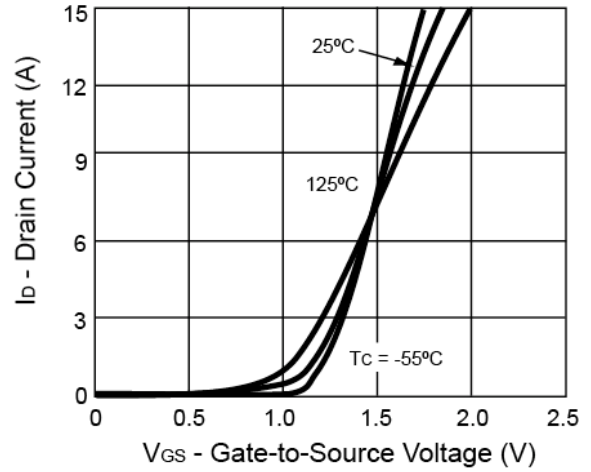
**Switchin Waveforms**

**Electrical Characteristics Curve** ( $T_a = 25^{\circ}\text{C}$ , unless otherwise noted)

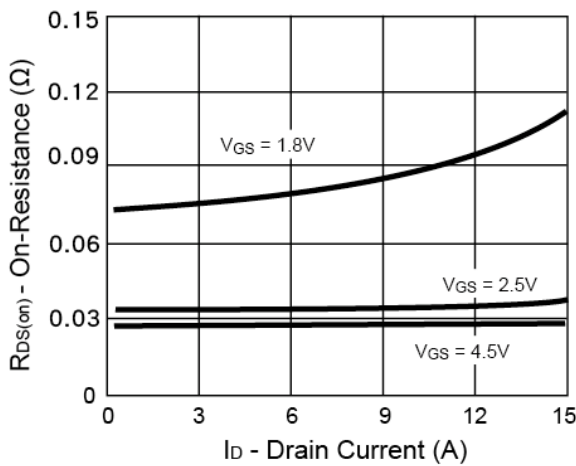
**Output Characteristics**



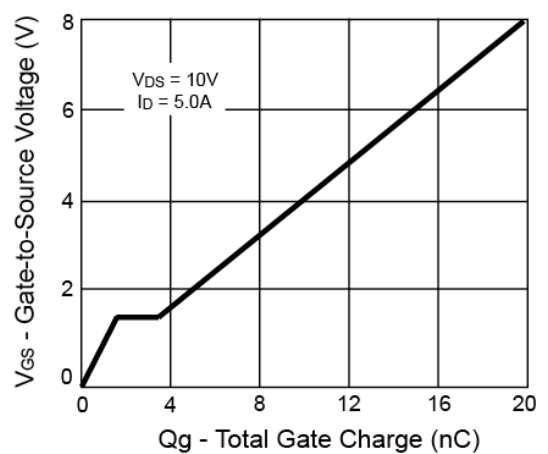
**Transfer Characteristics**



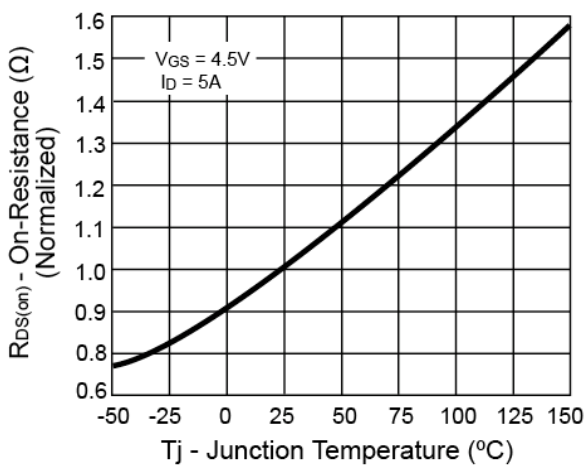
**On-Resistance vs. Drain Current**



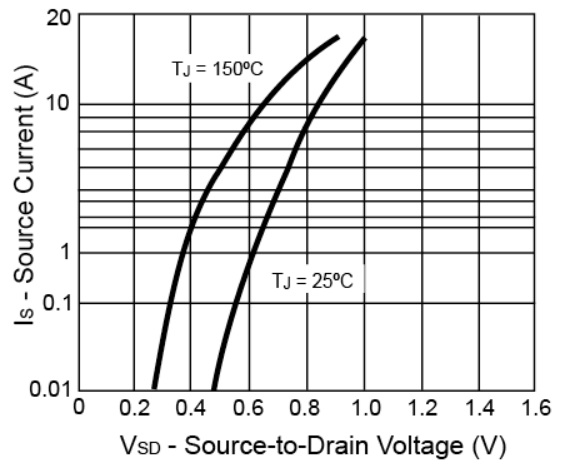
**Gate Charge**



**On-Resistance vs. Junction Temperature**

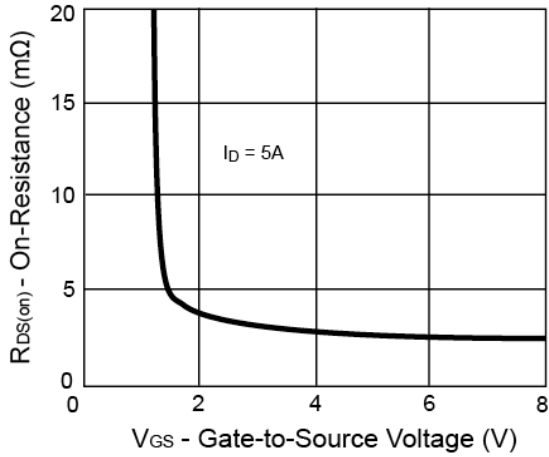


**Source-Drain Diode Forward Voltage**

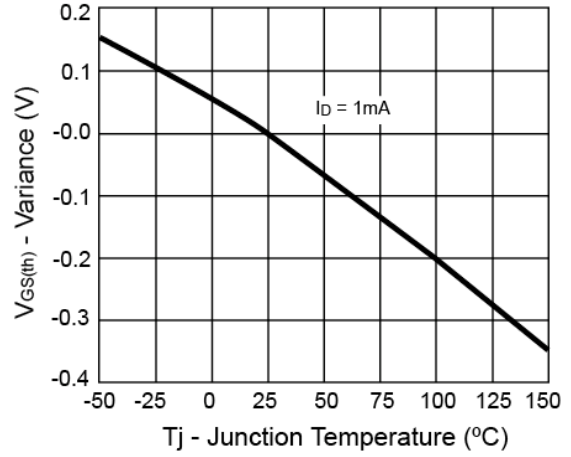


**Electrical Characteristics Curve** ( $T_a = 25^\circ\text{C}$ , unless otherwise noted)

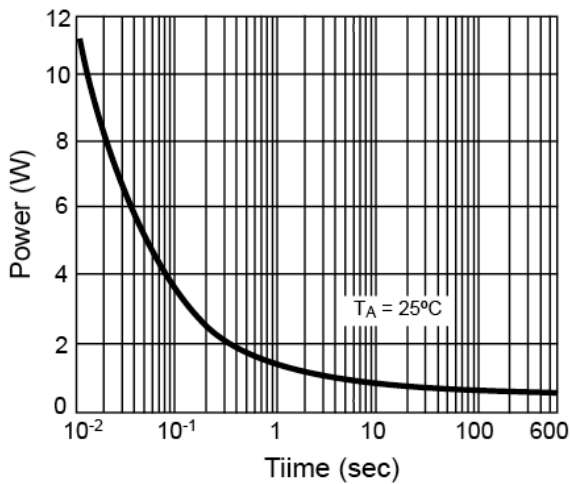
**On-Resistance vs. Gate-Source Voltage**



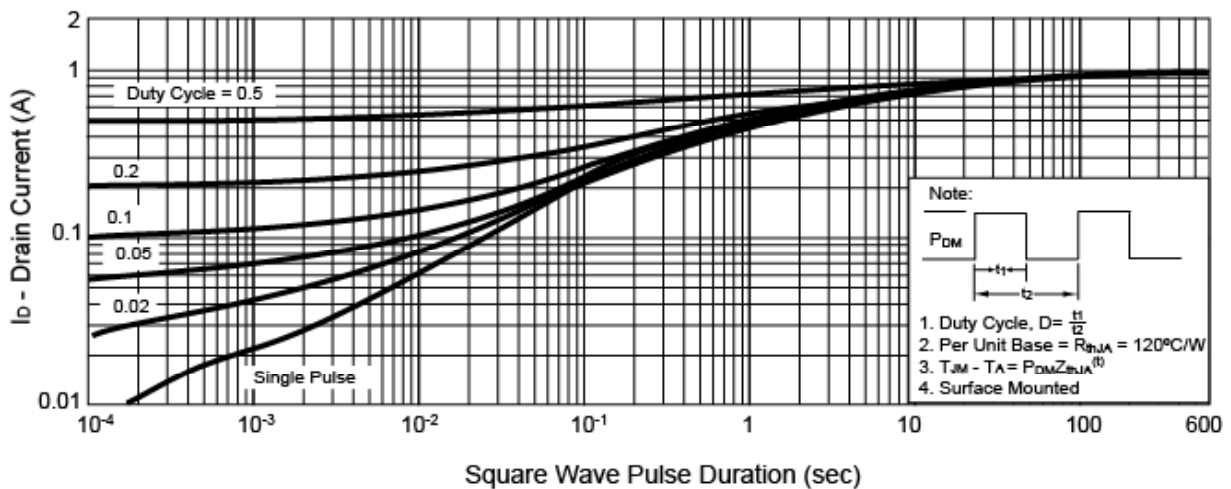
**Threshold Voltage**



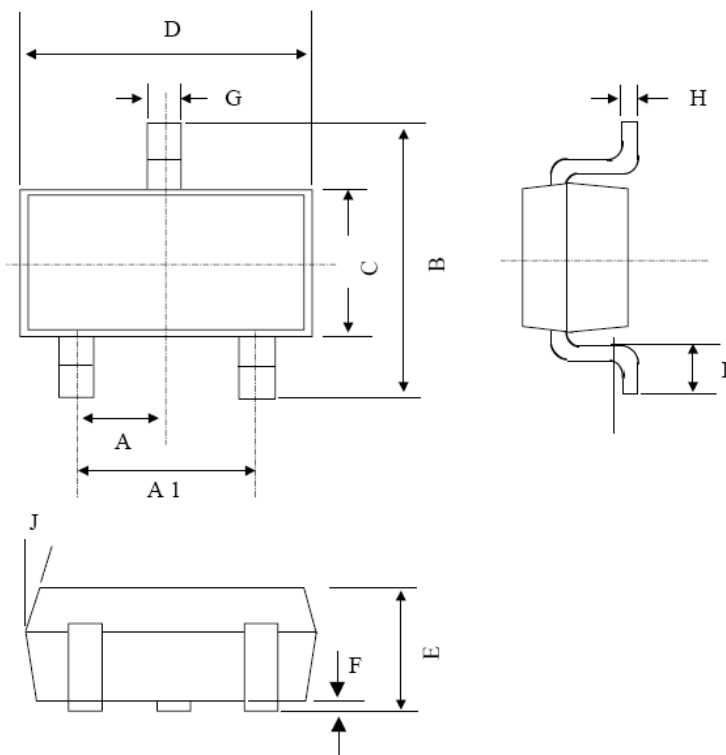
**Single Pulse Power**



**Normalized Thermal Transient Impedance, Junction-to-Ambient**

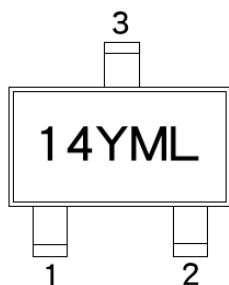


**SOT-23 Mechanical Drawing**



SOT-23 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX.
A	0.95 BSC		0.037 BSC	
A1	1.9 BSC		0.074 BSC	
B	2.60	3.00	0.102	0.118
C	1.40	1.70	0.055	0.067
D	2.80	3.10	0.110	0.122
E	1.00	1.30	0.039	0.051
F	0.00	0.10	0.000	0.004
G	0.35	0.50	0.014	0.020
H	0.10	0.20	0.004	0.008
I	0.30	0.60	0.012	0.024
J	5°	10°	5°	10°

**Marking Diagram**



- 14** = Device Code
- Y** = Year Code
- M** = Month Code  
(**A**=Jan, **B**=Feb, **C**=Mar, **D**=Apr, **E**=May, **F**=Jun, **G**=Jul, **H**=Aug, **I**=Sep, **J**=Oct, **K**=Nov, **L**=Dec)
- = Month Code for Halogen Free Product  
(**O**=Jan, **P**=Feb, **Q**=Mar, **R**=Apr, **S**=May, **T**=Jun, **U**=Jul, **V**=Aug, **W**=Sep, **X**=Oct, **Y**=Nov, **Z**=Dec)
- L** = Lot Code

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